

General Description

The MIC2026A and MIC2076A are high-side MOSFET switches optimized for general-purpose power distribution requiring circuit protection. The MIC2026A is particularly well suited for USB applications.

The MIC2026A/2076A are internally current limited and have thermal shutdown that protects the device and load.

The MIC2076A offers “smart” shutdown that reduces current consumption in fault modes. When the MIC2076A goes into thermal shutdown due to current limiting, the output is latched off until the switch is reset. The MIC2076A can be reset by removing the load, toggling the enable input, or cycling VIN.

Both devices employ soft-start circuitry that minimizes inrush current in applications where highly capacitive loads are employed.

A fault status output flag is asserted during overcurrent or thermal shutdown conditions. Transient faults are internally filtered.

The MIC2026A/2076A are available in an 8-pin SOIC package.

All support documentation can be found on Micrel’s web site at www.micrel.com.

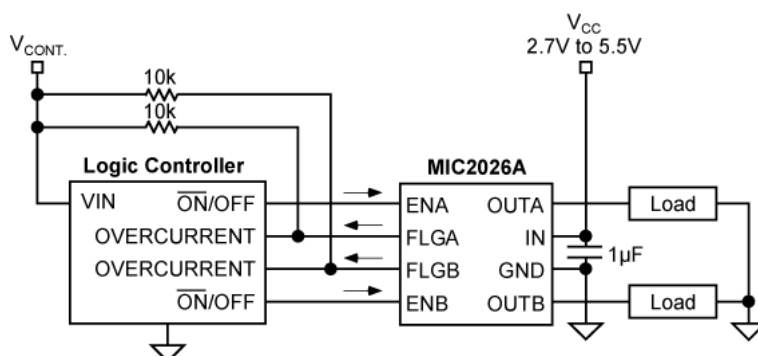
Features

- 100mΩ typical $R_{DS(ON)}$ at 5.0V
- 140mΩ maximum $R_{DS(ON)}$ at 5.0V
- 2.7 V to 5.5 V operating range
- 500mA minimum continuous current per channel
- Short circuit protection with thermal shutdown
- Thermally isolated channels
- Soft-start circuit
- Fault status flag with 3ms filter eliminates false assertions
- UVLO (Undervoltage lockout)
- Reverse current flow blocking (no “body diode”)
- Circuit breaker mode (MIC2076A)
- Pin compatible with the MIC2026/2076
- Logic-compatible inputs
- Low quiescent current

Applications

- USB peripherals
- General purpose power switching
- ACPI power distribution
- Notebook PCs
- PDAs
- PC card hot swap

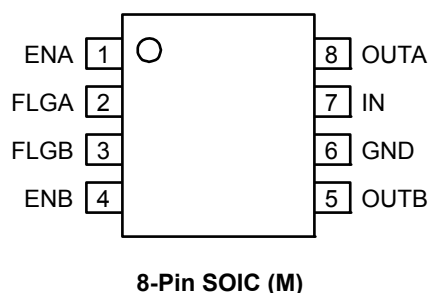
Typical Application



Ordering Information

Part Number	Enable	Temperature Range	Package	Lead Finish
MIC2026A-1YM	Active High	-40° to +85°C	8- Pin SOIC	Pb-Free
MIC2026A-2YM	Active Low	-40° to +85°C	8- Pin SOIC	Pb-Free
MIC2076A-1YM	Active High	-40° to +85°C	8- Pin SOIC	Pb-Free
MIC2076A-2YM	Active Low	-40° to +85°C	8- Pin SOIC	Pb-Free

Pin Configuration



Pin Description

Pin Number	Pin Name	Pin Function
1	ENA	Switch A Enable (Input): Logic-compatible, enable input. Active high (-1) or active low (-2).
2	FLGA	Fault Flag A (Output): Active-low, open-drain output. A logic LOW state Indicates overcurrent or thermal shutdown conditions. Overcurrent conditions must last longer than t_D in order to assert FLGA. The FLGA pin can be left floating; however, fault reporting information will be lost.
3	FLGB	Fault Flag B (Output): Active-low, open-drain output. A logic LOW state indicates overcurrent or thermal shutdown conditions. Overcurrent conditions must last longer than t_D in order to assert FLGB. The FLGB pin can be left floating; however, fault reporting information will be lost.
4	ENB	Switch B Enable (Input): Logic-compatible enable input. Active-high (-1) or active-low (-2).
5	OUTB	Switch B (Output).
6	GND	Ground.
7	IN	Input: Switch and logic supply input.
8	OUTA	Switch A (Output).

Absolute Maximum Ratings⁽¹⁾

Supply Voltage (V_{IN})	–0.3V to +6V
Output Voltage (OUTA and OUTB)	–0.3V to +6V
All other pins voltages	–0.3V to +6V
Fault Flag Current (I_{FLG})	25mA
Output Current (I_{OUT})	Internally Limited
Storage Temperature (T_S)	–65°C to +150 °C
ESD Rating ⁽³⁾	
HBM	3kV
MM	200V
Lead Temperature (Soldering 10 sec)	260°C

Operating Ratings⁽²⁾

Supply Voltage (V_{IN})	+2.7V to +5.5V
Ambient Temperature (T_A)	–40°C to +85°C
Junction Temperature Range (T_J)	Internally Limited
Thermal Resistance	
SOIC (θ_{JA})	160°C/W

Electrical Characteristics⁽⁴⁾

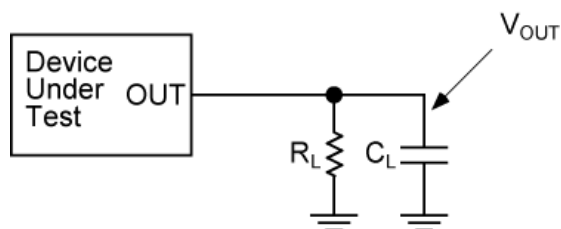
$V_{IN} = 5V$; $T_A = 25^\circ C$, unless noted, **bold** values indicate $-40^\circ C \leq T_A \leq +85^\circ C$.

Symbol	Parameter	Condition	Min	Typ	Max	Units
I_{DD}	Supply Current	MIC20X6A-1, $V_{ENA} = V_{ENB} = 0V$ (switch off), OUT = open		0.75	5	μA
		MIC20X6A-2, $V_{ENA} = V_{ENB} = 5V$ (switch off), OUT = open		0.75	20	μA
		MIC20X6A-1, $V_{ENA} = V_{ENB} = 5V$ (switch on), OUT = open		100	160	μA
		MIC20X6A-2, $V_{ENA} = V_{ENB} = 0V$ (switch on), OUT = open		100	160	μA
V_{EN}	Enable Input Threshold	low-to-high transition		1.6	2.4	V
		high-to-low transition	0.8	1.45		V
V_{EN_HYST}	Enable Input Hysteresis			150		mV
I_{EN}	Enable Input Current	$V_{EN} = 0V$ to 5V	-1	0.01	1	μA
C_{EN}	Enable Input Capacitance			1		pF
$R_{DS(ON)}$	Switch On Resistance	$V_{IN} = 5.0V$, $I_{OUT} = 500mA$		100	140	m Ω
		$V_{IN} = 3.3V$, $I_{OUT} = 500mA$		90	170	m Ω
$I_{LEAKAGE}$	Output Leakage Current	MIC20X6A-1, $V_{ENX} = 0V$; MIC20X6A-2, $V_{ENX} = V_{IN}$, (output off)		0.01	10	μA
		MIC2076A, Thermal shutdown state		50		μA
I_{LIMIT}	Short-Circuit Output Current	$V_{OUT} = 0V$, enabled into short-circuit	0.5	0.7	1.25	A
I_{LMT_TRSH}	Current-Limit Threshold	Ramped load applied to output		1.0	1.25	A
V_{UVLO}	Undervoltage Lockout Threshold (UVLO)	V_{IN} rising	2.2	2.45	2.7	V
		V_{IN} falling	2.0	2.25	2.5	V
V_{UVHYST}	UVLO Hysteresis	V_{IN} rising or V_{IN} falling		200		mV
R_{FLG}	Error Flag Output Resistance	$I_L = 10mA$		10	25	Ω
I_{FLG_OFF}	Error Flag Off Current	$V_{FLAG} = V_{IN}$			10	μA
t_{SC_RESP}	Short-Circuit Response Time	$V_{OUT} = 0V$, short circuit applied to enabled switch		20		μs
t_{ON}	Output Turn-On Delay	See Timing Diagrams, $R_L = 10\Omega$, $C_L = 1\mu F$		1.3	5	ms
t_R	Output Turn-On Rise Time	See Timing Diagrams, $R_L = 10\Omega$, $C_L = 1\mu F$	0.5	1.5	4.9	ms
t_{OFF}	Output Turn-Off Delay	See Timing Diagrams, $R_L = 10\Omega$, $C_L = 1\mu F$		32	100	μs

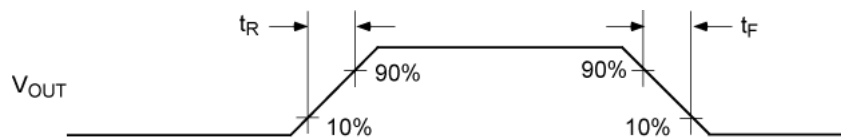
Symbol	Parameter	Condition	Min	Typ	Max	Units
t_F	Output Turn-Off Fall Time	See Timing Diagrams, $R_L = 10\Omega$, $C_L = 1\mu F$		32	100	μs
t_D	Overcurrent Flag Response Delay	From short circuit to FLG pin assertion	1.5	3.5	7	ms
$T_{OVERTEMP}$	Overtemperature Threshold ⁽⁵⁾	T_J increasing, each switch T_J decreasing, each switch		140 120		$^{\circ}C$ $^{\circ}C$
		T_J increasing, both switches T_J decreasing, both switches		160 150		$^{\circ}C$ $^{\circ}C$

Notes:

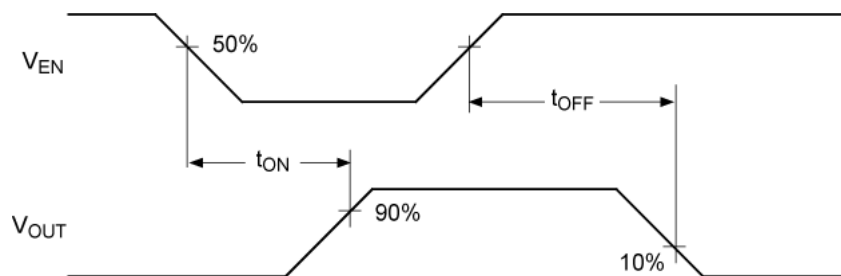
1. Exceeding the absolute maximum rating may damage the device.
2. The device is not guaranteed to function properly outside its operating rating.
3. Devices are ESD sensitive. Handling precautions recommended.
4. Specification for packaged product only.
5. If there is a fault on one channel, that channel will shut down when the die reaches approximately 140°C. If the die reaches approximately 160°C, both channels will shut down, even if neither channel is in current limit.

Test Circuit

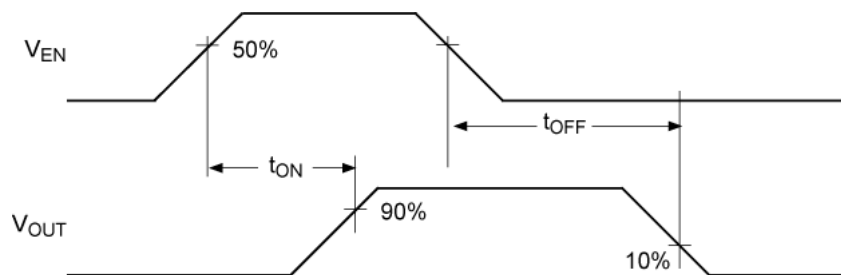
Timing Diagrams



Output Rise and Fall Times

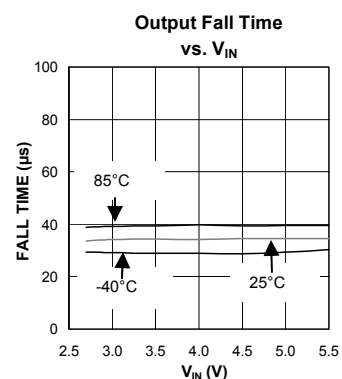
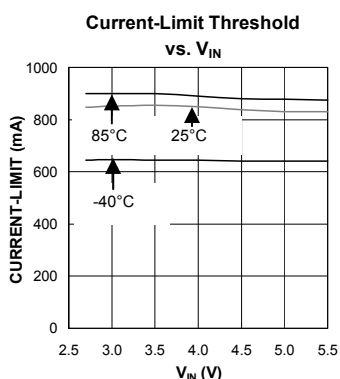
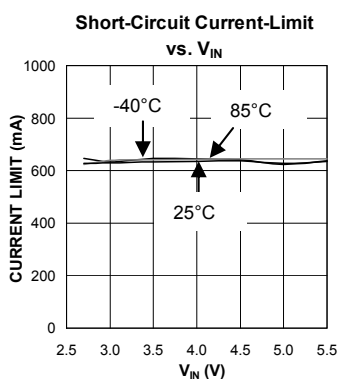
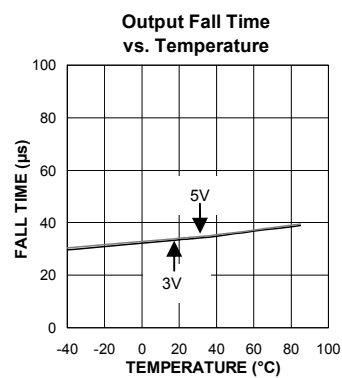
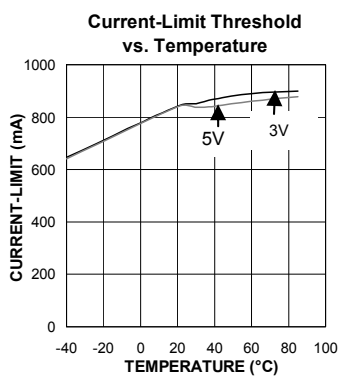
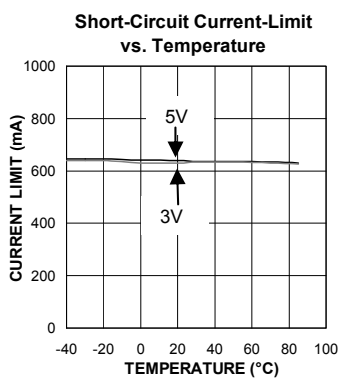
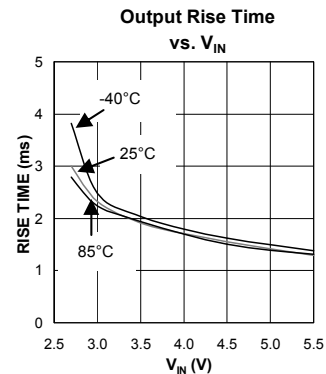
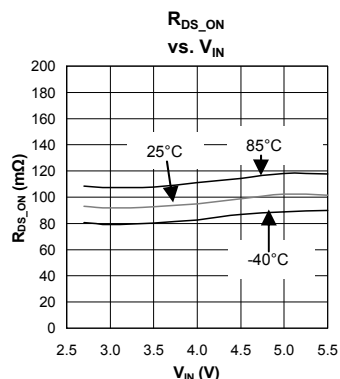
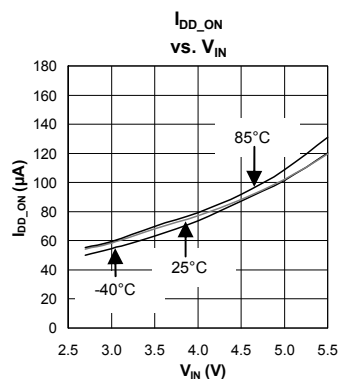
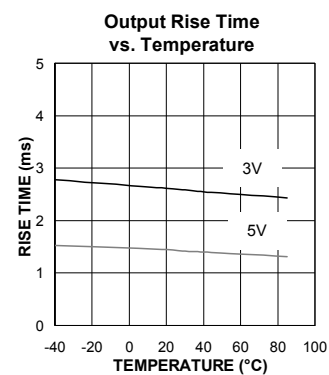
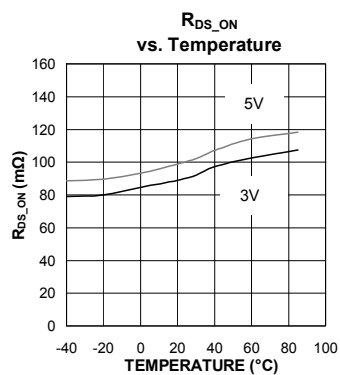
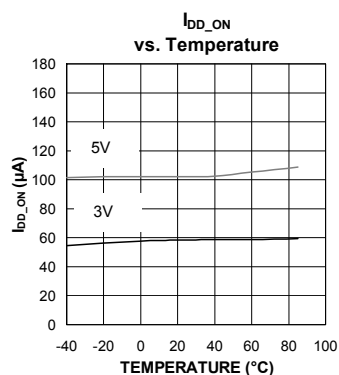


Active-Low Switch Delay Times (MIC20x6A-2)

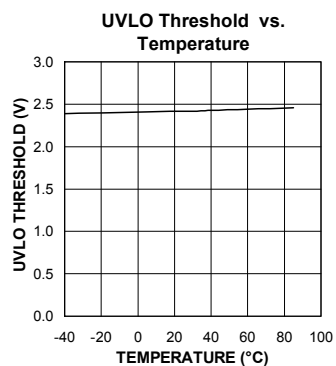
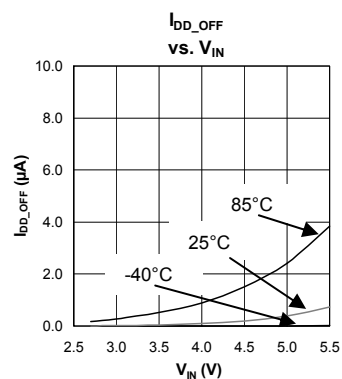
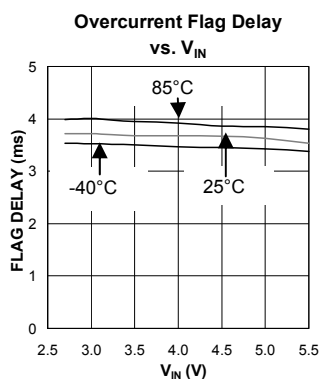
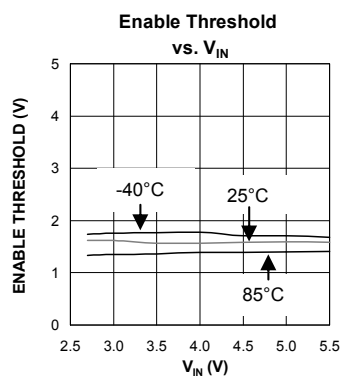
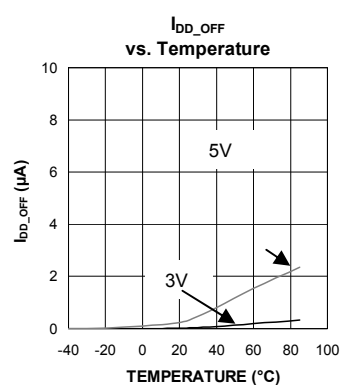
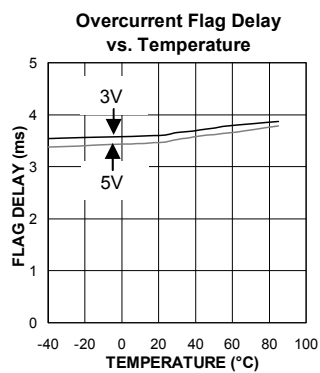
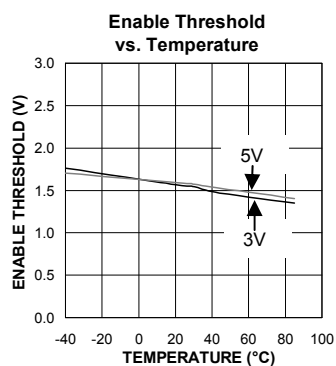


Active-High Switch Delay Time (MIC20x6A-1)

Typical Characteristics

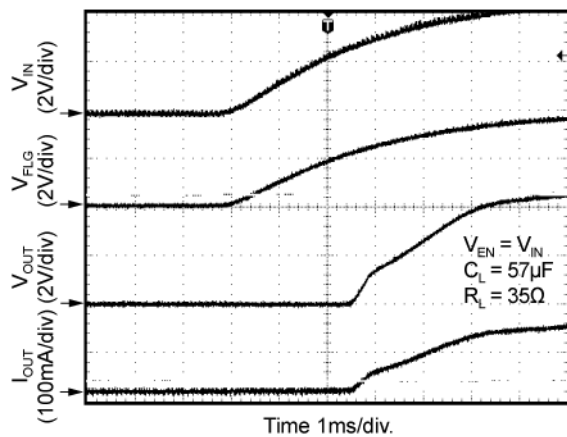


Typical Characteristics (continued)

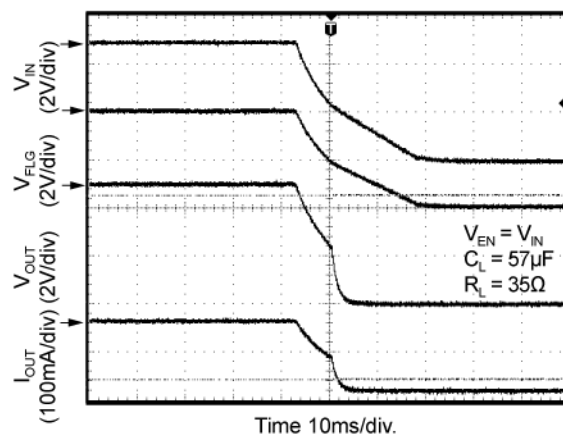


Functional Characteristics

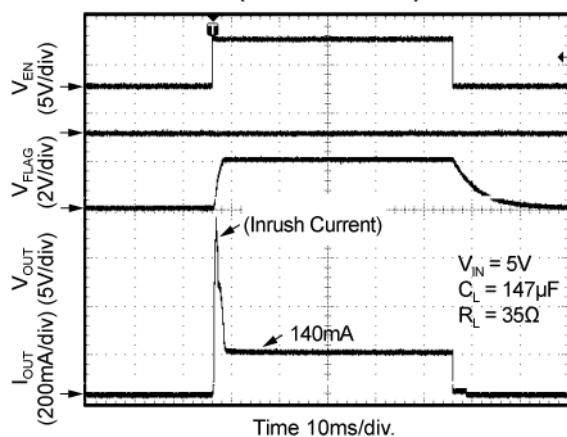
Soft-Start V_{IN} Turn-On



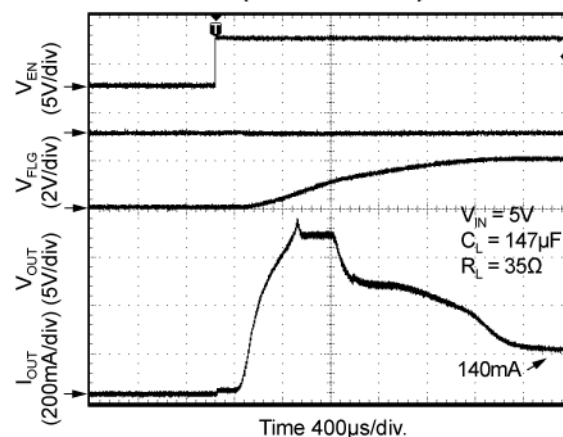
V_{IN} Turn-Off



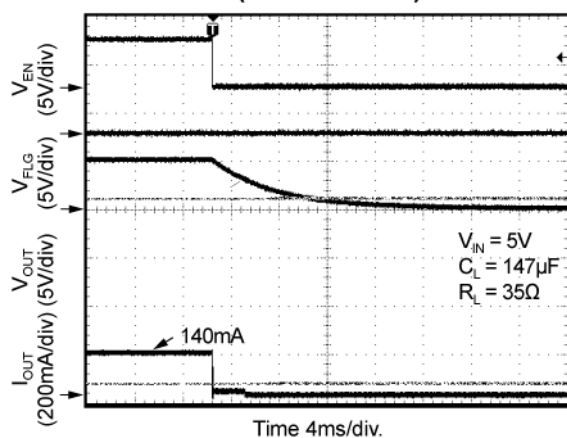
Turn-On/Turn-Off (MIC2026A-1)



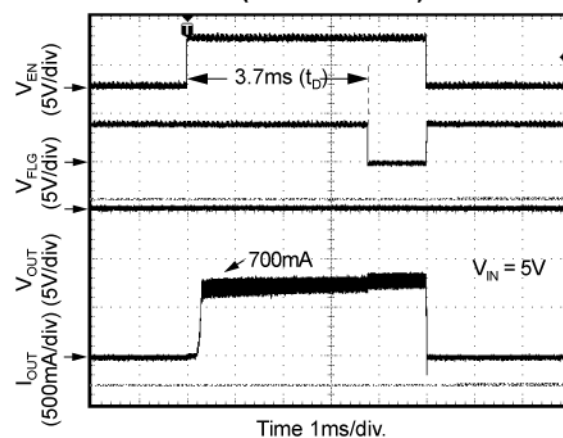
Turn-On Zoom (MIC2026A-1)



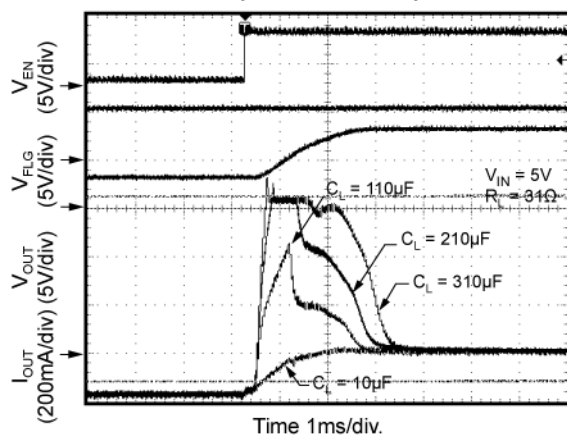
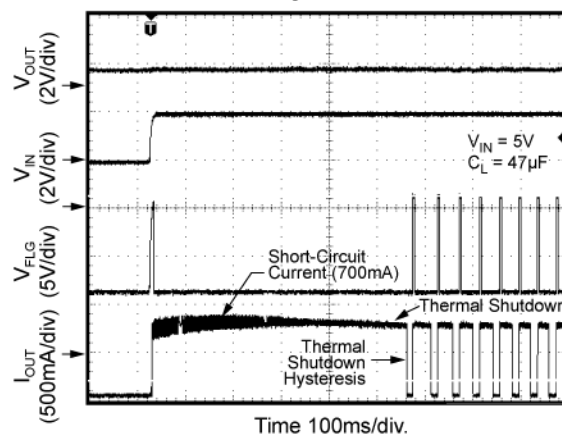
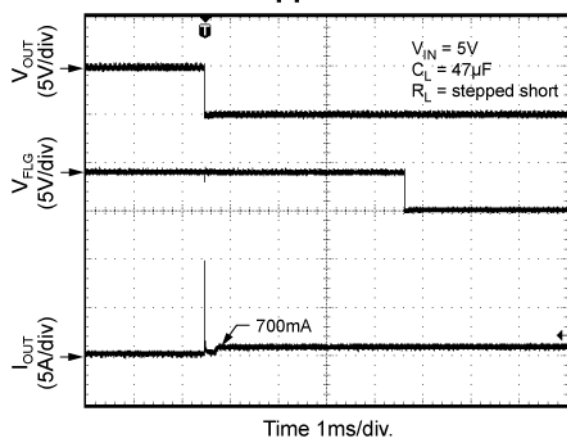
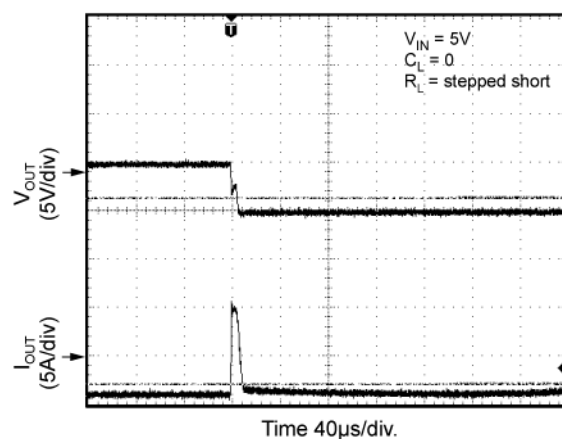
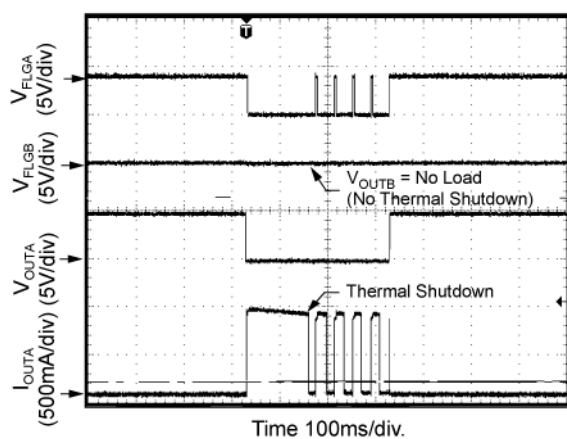
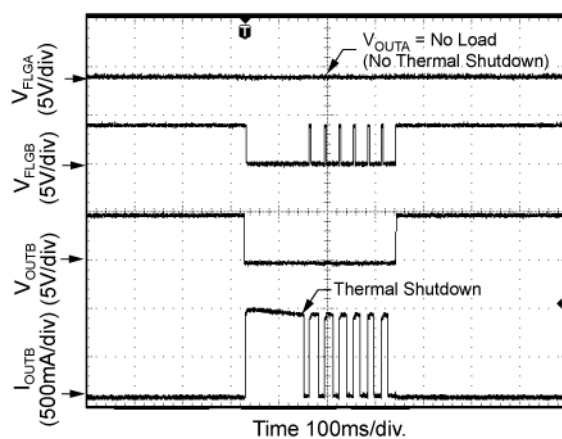
Turn-Off Zoom (MIC2026A-1)



Enabled into Short (MIC2026A-1)

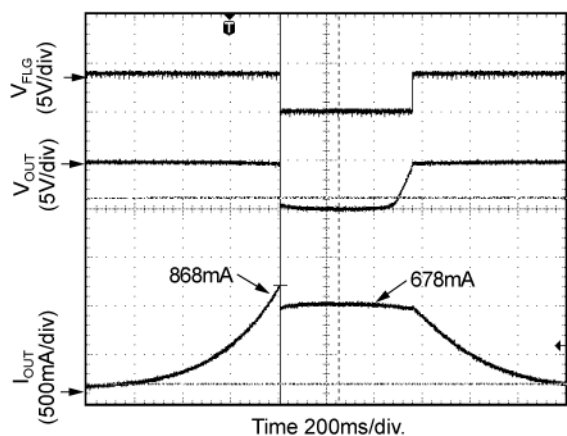


Functional Characteristics (continued)

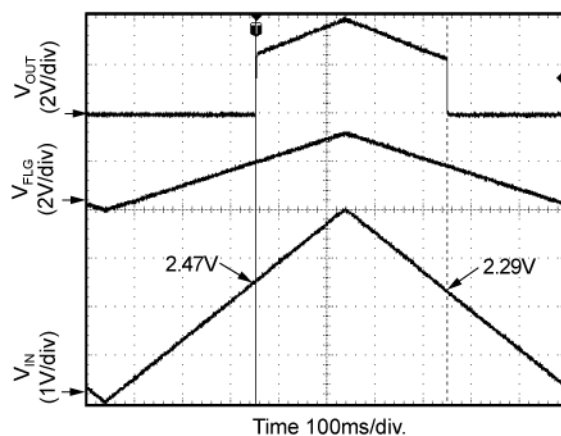
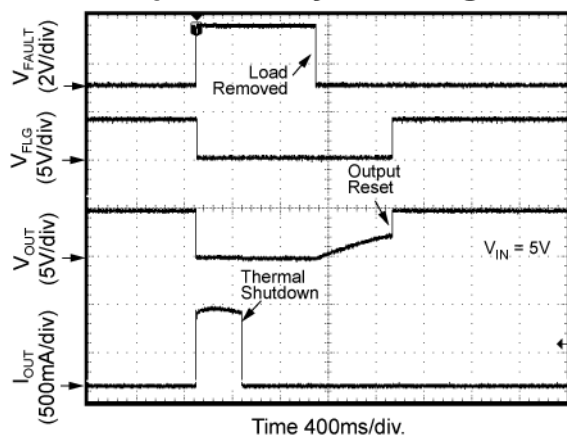
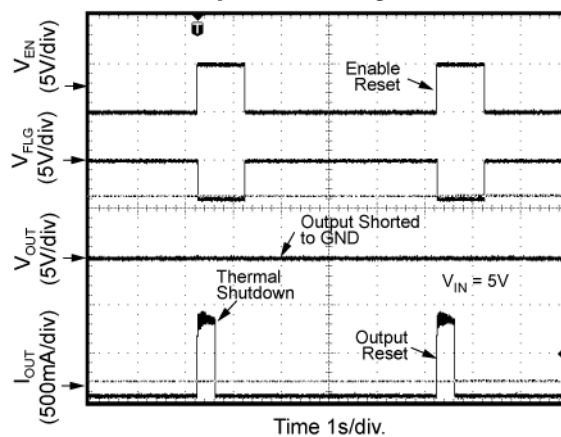
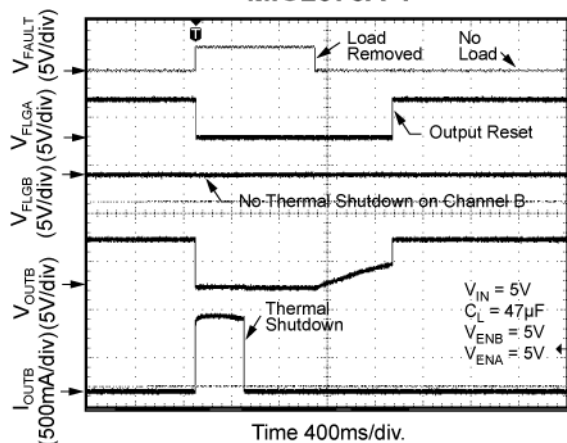
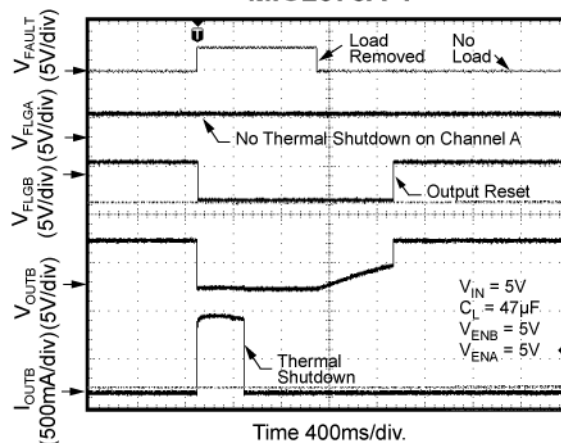
Inrush Current Response
(MIC2026A-1)Current Limit Response,
Output ShortCurrent Limit Response,
Stepped ShortCurrent Limit Threshold,
ZoomIndependent Thermal Shutdown,
Out AIndependent Thermal Shutdown,
Out B

Functional Characteristics (continued)

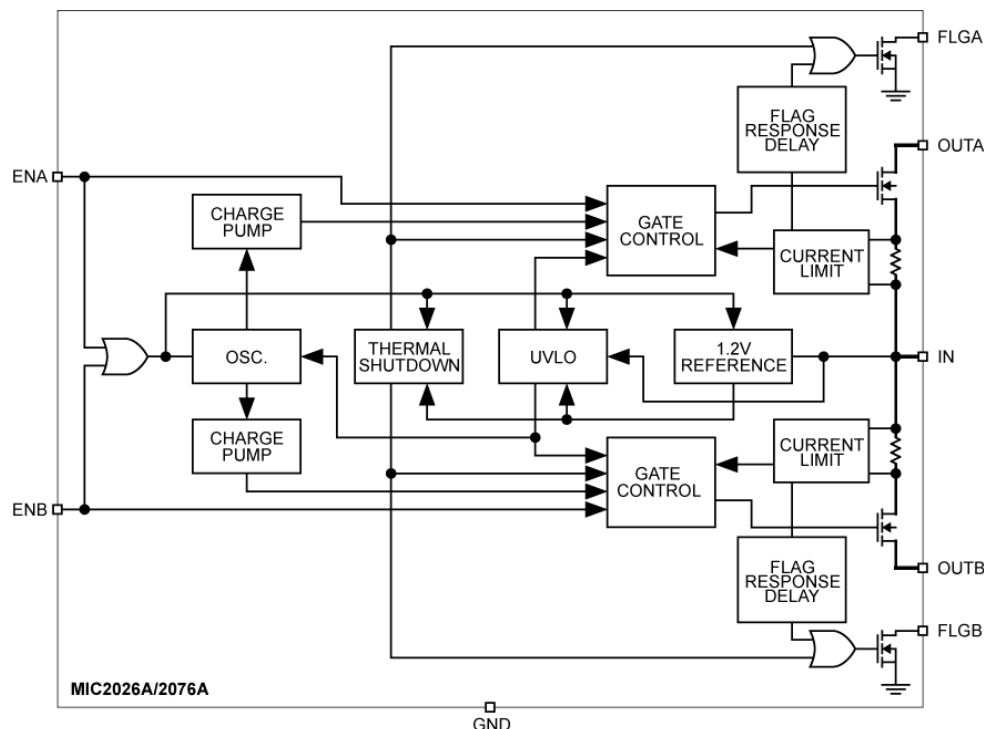
Current Limit Threshold



UVLO

Thermal Shutdown MIC2076A:
Output Reset by Removing LoadThermal Shutdown MIC2076A-1:
Output Reset by EnableIndependent Thermal Shutdown A
MIC2076A-1Independent Thermal Shutdown B
MIC2076A-1

Block Diagram



MIC2026A/2076A Block Diagram

Functional Description

Input and Output

IN is the power supply connection to the logic circuitry and the drain of the output MOSFET. OUT is the source of the output MOSFET. In a typical circuit, current flows from IN to OUT toward the load when the switch is enabled.

An important consideration in choosing a switch is whether it has “reverse voltage protection.” This is accomplished by eliminating the body diode during the fabrication process. Reverse voltage protection is important when the switch is disabled and a voltage is presented to the OUT pin that is greater than the VIN pin voltage. The reverse voltage protection prevents current flow in the reverse path from OUT to IN.

On other hand when the switch is enabled the switch is bidirectional. In this case when a voltage is presented to the OUT pin that is greater than the VIN voltage, current will flow from OUT to IN.

Thermal Shutdown

Thermal shutdown is employed to protect the device from damage should the die temperature exceed safe margins due mainly to short circuit faults. Each channel employs its own thermal sensor. Thermal shutdown shuts off the output MOSFET and asserts the FLG

output if the die temperature reaches 140°C and the overheated channel is in current limit. The other channel is not affected. If however, the die temperature exceeds 160°C, both channels will be shut off.

The MIC2026A will automatically reset its output when the die temperature cools down to 120°C. The MIC2026A's output and FLG signal will continue to cycle on and off until the device is disabled or the fault is removed. Figure 2 depicts typical timing.

On the other hand, the MIC2076A's output will be turned off, and remain off until the MIC2076A is reset. This is often called latched output, that is, the output is “latched” off and stays off. This is different from the MIC2026A's output that will cycle on and off. The MIC2076A will latch off the output when the MIC2076A is in current limiting and the switch goes in to thermal shutdown. Upon entering thermal shutdown, the output will be immediately latched off. The MIC2076A (latched output) can be reset by any of the following three methods:

1. Remove the fault load
2. Toggle the EN (Enable) pin
3. Cycle VIN (input power supply)

Resetting the MIC2076A will return it to normal operation.

Depending on PCB layout, package, ambient temperature, etc., it may take several hundred

milliseconds from the incidence of the fault to the output MOSFET being shut off. This time will be shortest in the case of a dead short on the output.

Power Dissipation

The device's junction temperature depends on several factors such as the load, PCB layout, ambient temperature, and package type. Equations that can be used to calculate power dissipation of each channel and junction temperature are found below:

$$P_D = R_{DS(on)} \times I_{OUT}^2$$

Total power dissipation of the device will be the summation of P_D for both channels. To relate this to junction temperature, the following equation can be used:

$$T_J = P_D \times \theta_{JA} + T_A$$

where:

T_J = junction temperature

T_A = ambient temperature

θ_{JA} = is the thermal resistance of the package

Current Sensing and Limiting

The current-limit threshold is preset internally. The preset level prevents damage to the device and external load but still allows a minimum current of 500mA to be delivered to the load.

The current-limit circuit senses a portion of the output MOSFET switch current. The current-sense resistor shown in the block diagram is a virtual and has no voltage drop. The reaction to an overcurrent condition varies with three scenarios:

- Switch Enabled into Short-Circuit**

If a switch is enabled into a heavy load or short-circuit, the switch immediately enters into a constant-current mode, reducing the output voltage. The FLG signal is asserted indicating an overcurrent condition.

- Short-Circuit Applied to Enabled Output**

When a heavy load or short-circuit is applied to an enabled switch, a large transient current may flow until the current-limit circuitry responds. Once this occurs, the device limits current to the short-circuit current limit specification.

- Current-Limit Response**

The MIC2026A/2076A current-limit response is often called the foldback current-limit. The foldback current-limit is the current limit reached when the output current is increased slowly rather than abruptly. An approximation of slowly is tens of milliamps per second. The foldback current-limit is typical 200 mA higher than the short-circuit current-limit. When the foldback current-limit is reached, the output current will abruptly decrease to the short-circuit current-limit.

Fault Flag

The FLG signal is an N-Channel open-drain MOSFET output. FLG is asserted (active-low) when either an overcurrent or thermal shutdown condition occurs. In the case of an overcurrent condition, FLG will be asserted only after the flag response delay time, t_D , has elapsed. This ensures that FLG is asserted only upon valid overcurrent conditions and that erroneous error reporting is eliminated. For example, false overcurrent conditions can occur during hot plug events when a highly capacitive load is connected and causes a high transient inrush current that exceeds the current-limit threshold for up to 1ms. The FLG response delay time t_D is typically 3ms.

Undervoltage Lockout

Undervoltage lockout (UVLO) prevents the output MOSFET from turning on until V_{IN} exceeds approximately 2.45V. Undervoltage detection functions only when the switch is enabled.

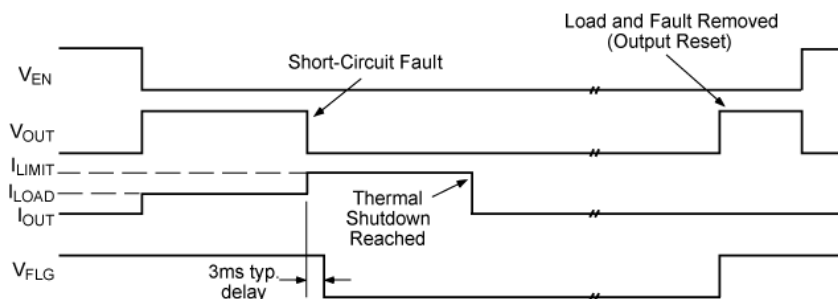


Figure 1. MIC2076A Fault Timing: Output Reset by Removing Load

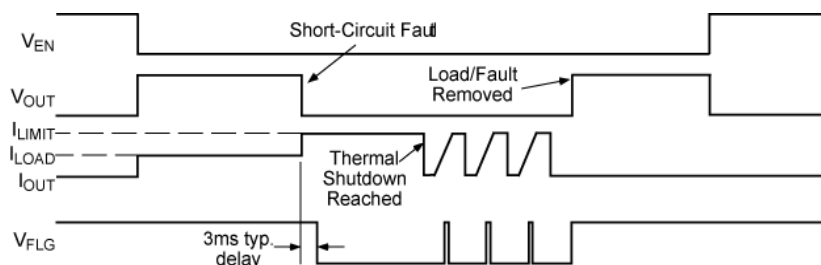


Figure 2. MIC2026A Fault Timing

Application Information

Supply Filtering

A 0.1 μ F to 1 μ F bypass capacitor positioned close to V_{IN} and GND pins of the device is strongly recommended to control supply transients. Without a bypass capacitor, an output short may cause sufficient ringing on the input (from supply lead inductance) to damage internal control circuitry.

Printed Circuit Board Hot-Plug

The MIC2026A/2076A are ideal inrush current-limiters for hot plug applications. Due to their integrated charge pumps, the MIC2026A/2076A present a high impedance when off and slowly become a low impedance as their integrated charge pumps turn on. This "soft-start" feature effectively isolates power supplies from highly capacitive loads by reducing inrush current. Figure 3 shows how the MIC2026A may be used in a card hot-plug application.

In cases of extremely large capacitive loads (>400 μ F), the length of the transient due to inrush current may exceed the delay provided by the integrated filter. Since this inrush current exceeds the current-limit delay specification, FLG will be asserted during this time. To prevent the logic controller from responding to FLG being asserted, an external RC filter, as shown in Figure 4, can be used to filter out transient FLG assertion. The value of the RC time constant should be selected to match the length of the transient, less $t_{D(min)}$ of the MIC2026A/2076A.

Universal Serial Bus (USB) Power Distribution

The MIC2026A/2076A are ideally suited for USB (Universal Serial Bus) power distribution applications. The USB specification defines power distribution for USB host systems such as PCs and USB hubs. Hubs can either be self-powered or bus-powered (that is, powered from the bus). Figure 5 shows a typical USB Host application that may be suited for mobile PC applications employing USB. The requirement for USB host systems is that the port must supply a minimum of 500mA at an output voltage of 5V $\pm$ 5%. In addition, the output power delivered must be limited to below 25VA. Upon an overcurrent condition, the host must also be notified. To support hot-plug events, the hub must have a minimum of 120 μ F of bulk capacitance, preferably low ESR electrolytic or tantalum. Please refer to Application Note 17 for more details on designing compliant USB hub and host systems.

For bus-powered hubs, USB requires that each downstream port be switched on or off under control by the host. Up to four downstream ports each capable of supplying 100mA at 4.4V minimum are allowed. In addition, to reduce voltage droop on the upstream V_{BUS} , soft-start is necessary. Although the hub can consume up to 500mA from the upstream bus, the hub must consume only 100mA max at start-up, until it enumerates with the host prior to requesting more power. The same requirements apply for bus-powered peripherals that have no downstream ports. Figure 6 shows a bus-powered hub.

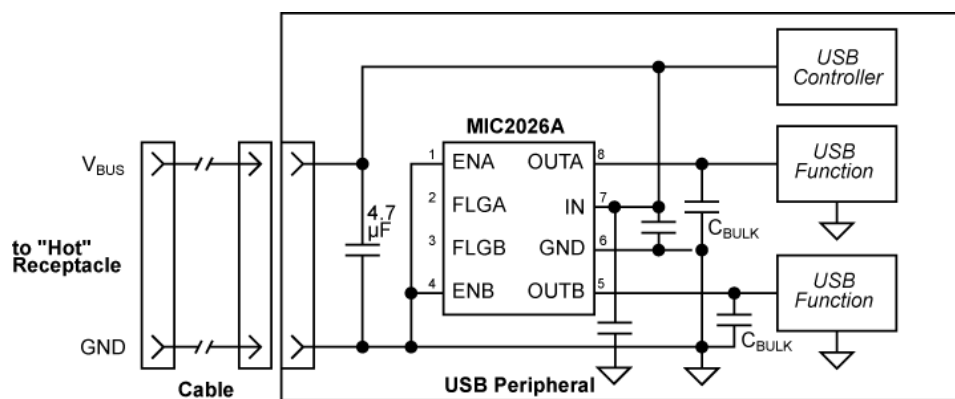


Figure 3. Hot-Plug Application

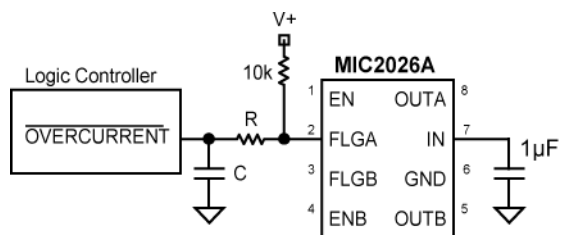


Figure 4. Transient Filter

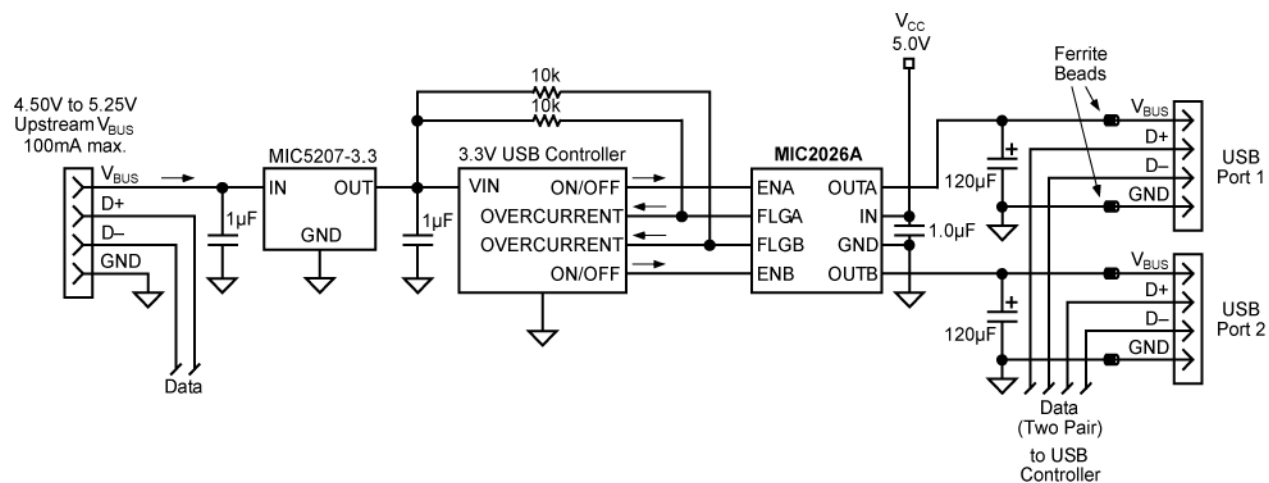


Figure 5. USB Two-Port Host Application

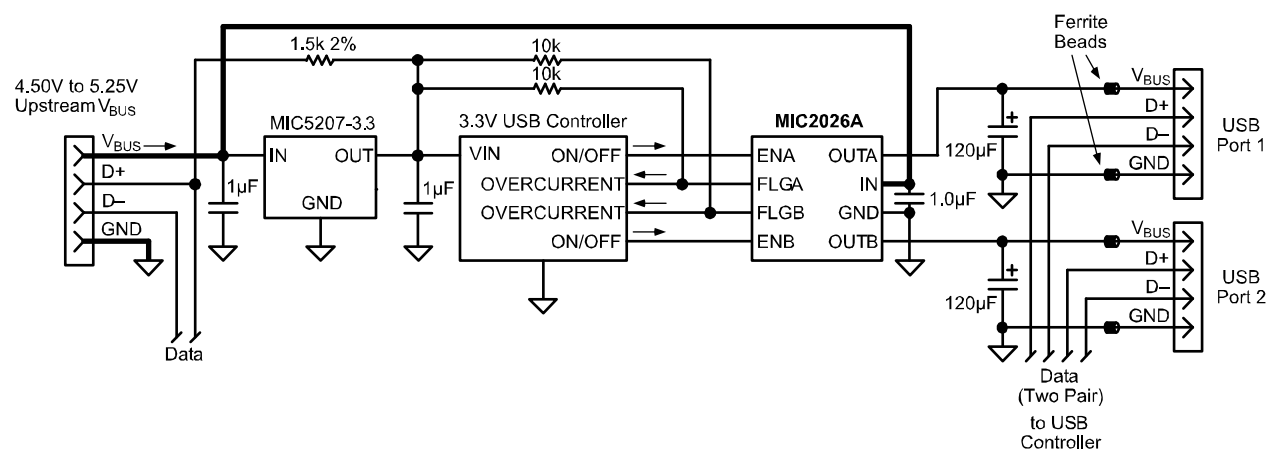
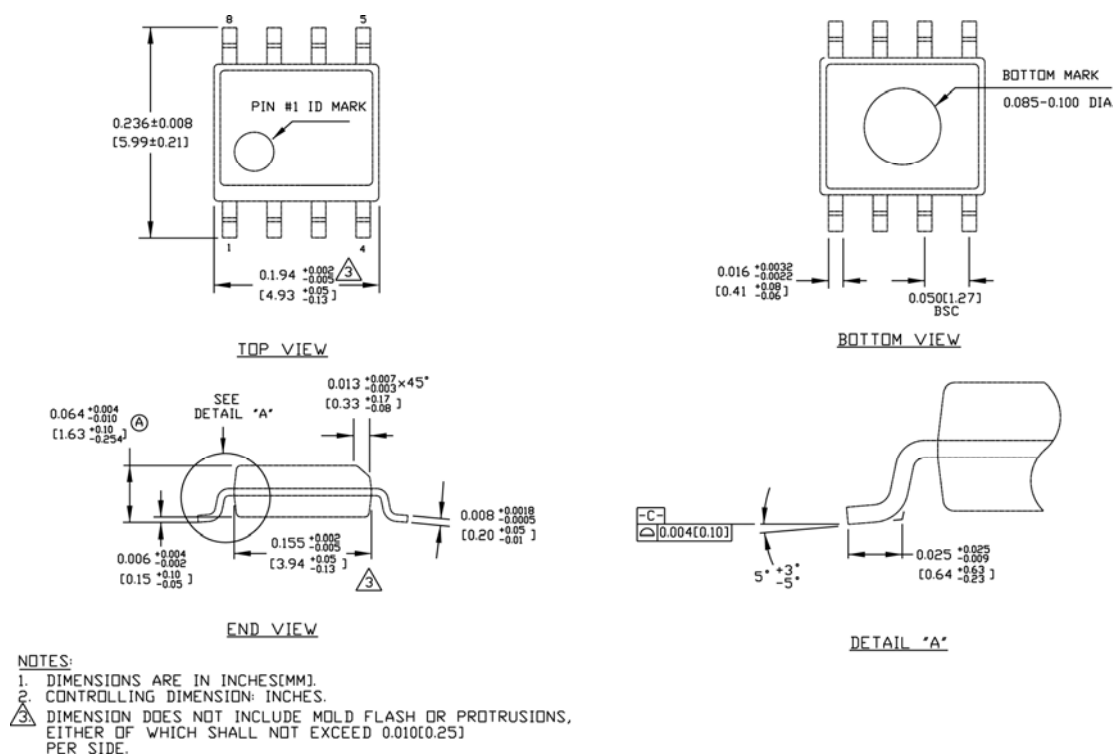


Figure 6. USB Two-Port Bus-Powered Hub

Package Information



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